

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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SERIAL NO.:

FILED: Herewith

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS  
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER FOIL  
MANUFACTURED THEREBY

PRELIMINARY AMENDMENT

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In conjunction with the filing of the present application, and prior to an initial Official Action on this matter, please amend the above-identified application as follows:

Preliminary Amendment: SPECIFICATION AMENDMENTS

In Paragraph [0019], please amend the paragraph as follows:

The present invention will become better understood with reference to the accompanying drawings which are given only by way of illustration and thus are not ~~limitative~~ restrictive of the present invention; ~~wherein,~~

In Paragraph [0020], please amend the paragraph as follows:

Figure 1 is a schematic view illustrating the construction of a copper manufacture apparatus for describing a method for manufacturing an electrodeposited copper foil according to the present invention; ,

In Paragraph [0021], please amend the paragraph as follows:

Figure 2 is a picture obtained by photographing an electrodeposited copper foil manufactured according to an embodiment 1 of the present invention using a SEM; ~~and,~~